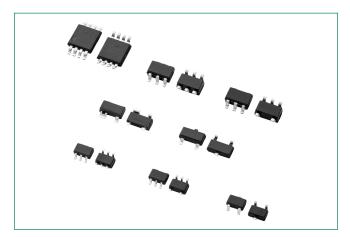
SP05 Series30pF 30kV Unidirectional TVS Array





Additional Information





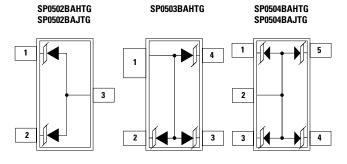


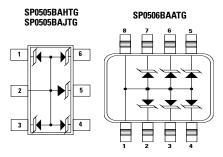
Resources

Accessories

Samples

Pinout





Description

This surface mount family of arrays suppress ESD and other transient overvoltage events. Used to meet the International Electrotechnical Compatibility (IEC transient immunity standards IEC 61000-4-2 for Electrostatic Discharge Requirements), these components can help protect sensitive digital or analog input circuits on data, signal, or control lines with voltage levels up to 5VDC.

The monolithic silicon arrays are comprised of specially designed structures for transient voltage suppression (TVS). The size and shape of these structures have be tailored for transient protection. Compared to MOVs, this diode array provides a lower clamping voltage and lower off-state capacitance.

Features & Benefits

- An Array of 2, 3, 4, 5 or 6 TVS Avalanche Diodes in a ultra small SC70, SOT-23, SOT-143 or MSOP packages
- ESD Capability Standards
 - IEC 61000-4-2, Direct Discharge 30kV (Level 4)
 - - IEC 61000-4-2, Air Discharge 30kV (Level 4)
 - MIL STD 883 3015.7 30kV
- Input Protection for Applications Up to 5VDC
- Fast Response Time <1ns
- Low Input Capacitance 30pF Typical
- Operating Temperature Range -40°C to 125°C
- Moisture Sensitivity Level (MSL-1)

Applications

- Mobile phone handsets
- Personal Digital Assistants (PDA)
- Portable handheld equipment (Laptop, Palmtop computers)
- Computer port, keyboard (USB1.1)
- Digital still cameras
- Digital video cameras
- MP3 players

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
P _{PK}	Peak Pulse Power (t _p =8/20µs)	25	W
I _{PP}	Peak Pulse Current (t _p =8/20μs)	3	А
T _{OP}	Operating Temperature	-40 to 125	°C
T_{STOR}	Storage Temperature	-55 to 150	°C

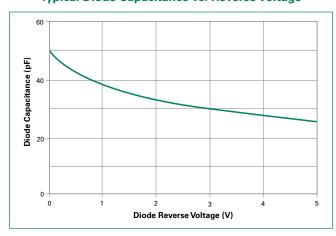
Caution: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics ($T_A = +25^{\circ}\text{C}$, Unless Otherwise Specified)

Parameter	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	$I_R \le 1\mu A$	-	-	5.5	V
Reverse Standoff Leakage Current	V = 5.0V	-	1	100	nA
Signal Clamp Voltage					
Positive	I = 1mA	6.0	-	8.5	V
Negative	I = 10mA	-1.2	-0.8	-0.4	V
Clamp Voltage during ESD					
MIL-STD-883 Method 3015 (HBM) test	-	-	-	-	-
+ 8kV	-	-	12	-	V
- 8kV	-	-	-8	-	V
ESD Test Level (1)					-
IEC-61000-4-2, Contact discharge	-	30	-	-	kV
MIL-STD-883 Method 3015 (HBM)	-	30	-	-	kV
Capacitance	2.5V @ 1MHz	-	30	-	pF
Turn on/off Time	-	-	<1	-	ns
Diode Dynamic Resistance					-
Forward Conduction	-	-	1.0	-	Ω
Reverse Conduction	-	-	1.4	-	Ω

Note:

Typical Diode Capacitance vs. Reverse Voltage

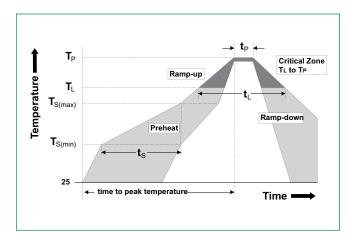




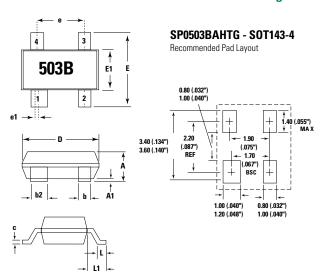
^{1.} ESD voltage applied between channel pins and ground, one pin at a time; all other channel pins are open; all ground pins are grounded.

Soldering Parameters

Reflow Cond	dition	Pb – Free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 120 secs
Average ram peak	np up rate (Liquidus) Temp (T _L) to	5°C/second max
T _{S(max)} to T _L - Ramp-up Rate		5°C/second max
Reflow	-Temperature (T _L) (Liquidus)	217°C
nellow	-Temperature (t _L)	60 - 150 seconds
Peak Temper	rature (T _P)	260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (tp)		30 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T _p)		8 minutes Max.
Do not exce	ed	260°C



Package Dimensions — SOT143

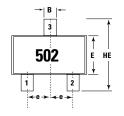


Package	SOT143-4				
Pins	4				
JEDEC		TO-	253		
Symbol	Millin	neters	Inc	hes	
Syllibol	Min	Max	Min	Max	
Α	0.8	1.22	0.03	0.048	
A1	0.05	0.15	0.002	0.006	
b	0.30	0.50	0.012	0.020	
b2	0.76	0.89	0.030	0.035	
С	0.08	0.20	0.003	0.008	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.082	0.104	
E1	1.20	1.40	0.047	0.055	
е	1.92 BSC		0.076 BSC		
e1	0.20 BSC		0.008	BSC	
L	0.4	0.6	0.016	0.024	
L1	0.550 REF		0.022	REF	

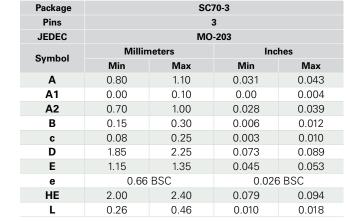


30pF 30kV Unidirectional TVS Array

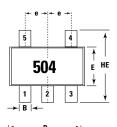
Package Dimensions — SC70



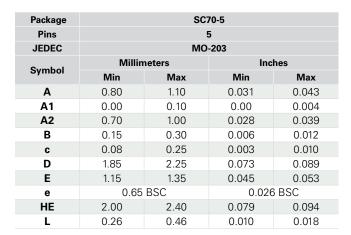
SP0502BAJTG - SC70-3

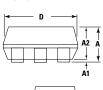




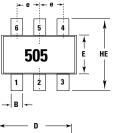


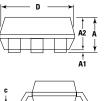
SP0504BAJTG - SC70-5



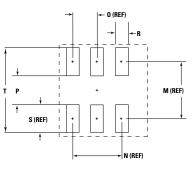








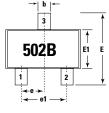
SP0505BAJTG - SC70-6 Recommended Pad Layout

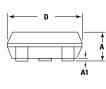


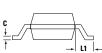
Package	SC70-6				
Pins	6				
JEDEC		МО	-203		
	Millim	neters	Inches		
Symbol	Min	Max	Min	Max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
C	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.65	BSC	0.026 BSC		
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	
M	-	1.60	-	0.063	
N	-	1.30	-	0.051	
0	-	0.65	-	0.026	
P	-	0.70	-	0.028	
R	-	0.35	-	0.014	
S	-	0.90	-	0.035	
Т	-	2.50	-	0.098	

30pF 30kV Unidirectional TVS Array

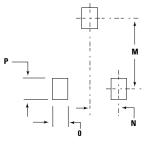
Package Dimensions — SOT23



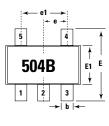




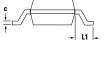




Package	SOT23-3					
Pins JEDEC	3 TO-236					
JEDEC	Millim					
Symbol	Min	Max	Min	Max		
Α	0.89	1.12	0.035	0.044		
A1	0.01	0.1	0.0004	0.004		
b	0.3	0.5	0.012	0.020		
С	0.08	0.2	0.003	0.008		
D	2.8	3.04	0.110	0.120		
E	2.1	2.64	0.083	0.104		
E1	1.2	1.4	0.047	0.055		
е	0.95	BSC	0.038 BSC			
e1	1.90	BSC	0.075	BSC		
L1	0.54	REF	0.021	REF		
M		2.29		0.090		
N		0.95		0.038		
0		0.78		0.030TYP		
P		0.78		0.030TYP		

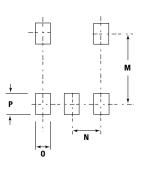




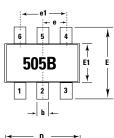


SP0504BAHTG - S0T23-5

Recommended Pad Layout



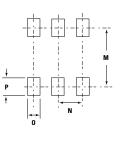
Package	SOT23-5				
Pins			5		
JEDEC		MO	-178		
Compleal	Millin	neters	Inc	hes	
Symbol	Min	Max	Min	Max	
Α	-	1.45	-	0.057	
A1	0	0.15	0	0.006	
b	0.25	0.5	0.0098	0.020	
C	0.08	0.22	0.003	0.009	
D	2.75	3.05	0.108	0.120	
E	2.6	3.0	0.102	0.118	
E1	1.45	1.75	0.057	0.069	
е	0.95	BSC	0.038	8 BSC	
e1	1.90 BSC		0.075 BSC		
L1	0.60 REF		0.024	l REF	
M		2.59		.102	
N		0.95		.038	
0		0.69		.027TYP	
P		0.99		.039TYP	





SP0505BAHTG - S0T23-6

Recommended Pad Layout

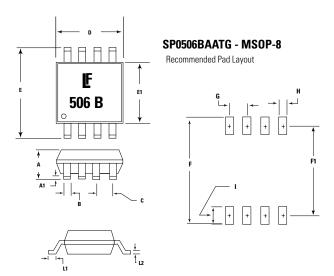


Package	SOT23-6					
Pins	6					
JEDEC		MO	-178			
Cumbal	Millin	neters	Inc	hes		
Symbol	Min	Max	Min	Max		
Α	-	1.45	-	0.057		
A1	0	0.15	0	0.006		
b	0.25	0.5	0.0098	0.020		
C	0.08	0.22	0.003	0.009		
D	2.75	3.05	0.108	0.120		
E	2.6	3.0	0.102	0.118		
E1	1.45	1.75	0.057	0.069		
е	0.95	BSC	0.038 BSC			
e1	1.90	BSC	0.075	BSC		
L1	0.60 REF		0.024	l REF		
M		2.59		.102		
N		0.95		0.038		
0		0.69		.027TYP		
P		0.99		.039TYP		



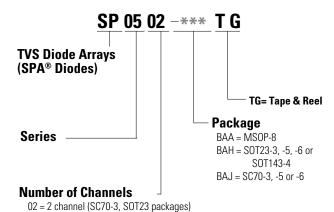
30pF 30kV Unidirectional TVS Array

Package Dimensions — MSOP



Package	MSOP				
Pins	8				
JEDEC		MO-	-187		
Symbol	Millin	neters	Inc	hes	
Зуппон	Min	Max	Min	Max	
D	2.90	3.10	0.114	.122	
E	4.78	4.98	.188	.196	
E1	2.90	3.10	.114	.122	
Α	0.87	1.17	.034	.046	
A1	0.05	0.25	.002	0.010	
В	-	0.30TYP	-	0.012TYP	
С	-	0.65TYP	-	0.026TYP	
L1	0.52	0.54	0.020	0.021	
L2	-	0.18TYP	-	.007TYP	
F	-	5.28	-	.208	
F1	-	4.24	-	.167	
G	-	0.65	-	0.026	
Н	-	0.38	-	.015	
l	-	1.04	-	.041	

Part Numbering System



Ordering Information

03 = 3 channel (SOT143 package)

Part Number	СН	Package Type	Quantity Per Reel
SP0502BAHTG	2	SOT23-3	3000
SP0503BAHTG	3	SOT143-4	3000
SP0504BAHTG	4	SOT23-5	3000
SP0505BAHTG	5	SOT23-6	3000
SP0506BAATG	6	MSOP-8	4000
SP0502BAJTG	2	SC70-3	3000
SP0504BAJTG	4	SC70-5	3000
SP0505BAJTG	5	SC70-6	3000

*Note: To order NON-Green/RoHS/Lead Free version of product, remove "G" at the end of part number.

Product Characteristics

Lead Plating	"G" Green version - Matte Tin (Sn)
Lead Material	Copper / Iron Alloy
Lead Coplanarity	0.004 inches (0.102mm)
Substrate Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

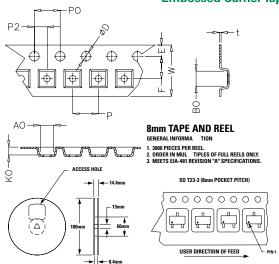
Notes:

- All dimensions are in millimeters.
- 2. Dimensions include solder plating.
- 3. Dimensions are exclusive of mold flash & metal burr.
 4. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
 5. Package surface matte finish VDI 11-13.



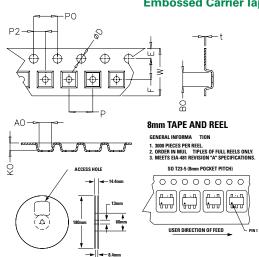
30pF 30kV Unidirectional TVS Array

Embossed Carrier Tape & Reel Specification — SOT23-3



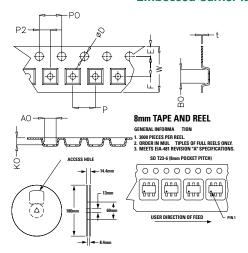
Comple al	Millimetres		Inc	hes
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
P	3.90	4.10	0.154	0.161
A0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009

Embossed Carrier Tape & Reel Specification — SOT23-5



Symbol	Millimetres		Inches	
	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
P	3.90	4.10	0.154	0.161
A0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009

Embossed Carrier Tape & Reel Specification — SOT23-6

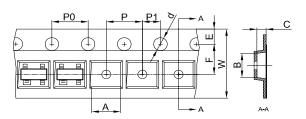


Symbol	Millimetres		Inches	
	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
P	3.90	4.10	0.154	0.161
A0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009



30pF 30kV Unidirectional TVS Array

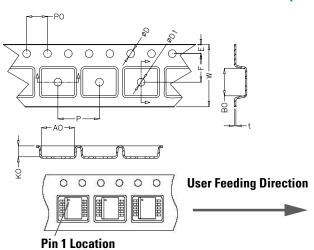
Embossed Carrier Tape & Reel Specification — SOT143-4



Trailer Tape	Components	Leader Tape
Pin 1	User Feeding Direction	

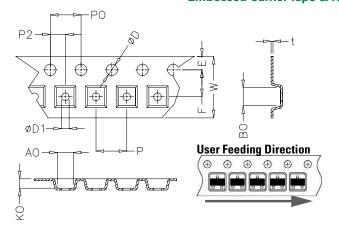
Symbol	Millimetres		Inches	
	Min	Max	Min	Max
Α	3.09	3.09	0.122	0.130
В	2.70	2.90	1.106	0.114
С	1.21	1.41	0.048	0.056
d	1.40	1.60	0.055	0.102
E	1.65	0.85	0.065	0.073
F	3.45	3.65	0.133	0.142
P0	4.10	3.90	0.154	0.161
Р	4.10	3.90	0.154	0.161
P1	1.90	2.10	0.075	0.083
W	7.90	8.10	0.311	0.319

Embossed Carrier Tape & Reel Specification — MSOP-8



Symbol	Millimetres		Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	5.40	5.60	0.213	0.220
D	1.50	1.60	0.059	0.063
D1	1.50 Min		0.059 Min	
P0	3.90	4.10	0.154	0.161
W	11.70	12.30	0.461	0.484
Р	7.90	8.10	0.311	0.319
A0	5.20	5.40	0.205	0.213
В0	3.30	3.40	0.126	0.134
K0	1.20	1.40	0.047	0.055
t	0.30 ± 0.05		0.012± 0.002	

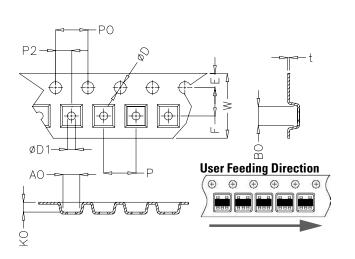
Embossed Carrier Tape & Reel Specification — SC70-3



Symbol	Millimetres		Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
Р	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27 Max		0.010 Max	

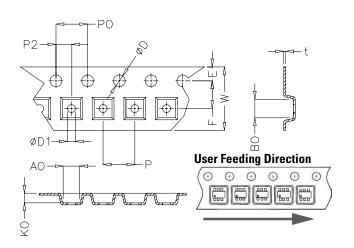


Embossed Carrier Tape & Reel Specification — SC70-5



Symbol	Millimetres		Inches	
	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
Р	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27 Max		0.010 Max	

Embossed Carrier Tape & Reel Specification — SC70--6



Symbol	Millimetres		Inches	
	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
P	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27 Max		0.010	Max

Disclaimer Notice - Littelfuse products are not designed for, and shall not be used for, any purpose (including, without limitation, automotive, military, aerospace, medical, life-saving, life-saving,

